

### 3.0x1.0mm RIGHT ANGLE SMD CHIP LED LAMP

#### **Features**

- $\bullet$  3.0 X 1.0 X 1.5mm right angle SMD LED
- Ideal for indication on hand held products
- Low current operation
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- RoHS compliant

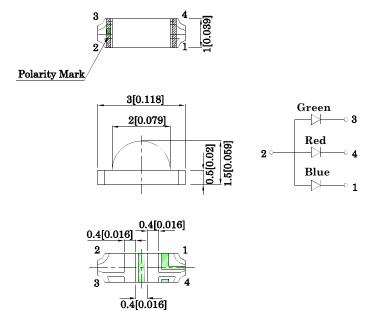






# ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

# Package Schematics



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings ( $T_A$ =25°C)		Blue (InGa N)	Green (InGa N)	Red (AlGa InP)	Unit
Reverse Voltage	$V_{\mathrm{R}}$	5	5	5	V
Forward Current	$I_{\mathrm{F}}$	30	25	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\mathrm{FS}}$	150	150	195	mA
Power Dissipation	$P_{D}$	120	102.5	75	mW
Electrostatic Discharge Threshold (HBM)		250	450	3000	V
Operating Temperature	$T_{\rm A}$		°C		
Storage Temperature	Tstg	-40 ~ +85			

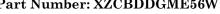
A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics $(T_A=25^{\circ}C)$		Blue (InGaN)	Green (InGaN)	Red (AlGaInP)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	3.3	3.3	2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	4	4.1	2.5	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	50	50	10	uA
Wavelength of Peak Emission CIE127-2007*(Typ.) (I <sub>F</sub> =20mA)	λР	460*	515*	630*	nm
Wavelength of Dominant Emission CIE127-2007*(Typ.) $(I_F=20 \text{mA})$	λD	465*	525*	621*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	Δλ	25	35	20	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	100	45	25	pF

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(I_F=20mA)} \\ \text{mcd} \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
	Blue	InGaN		40*	69*	460*	
XZCBDDGME56W	Green	InGaN	- Water Clear	300*	497*	515*	150°
	Red	AlGaInP	_	80*	138*	630*	

<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Aug  $24,\,2017$ 

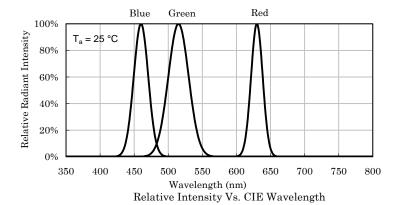
XDSB6706 V3-Z Layout: Maggie L.

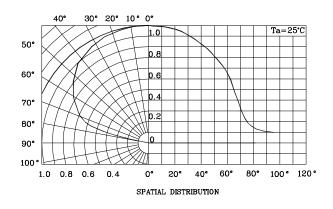


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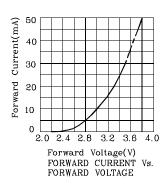


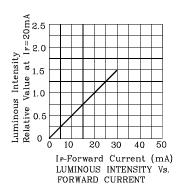


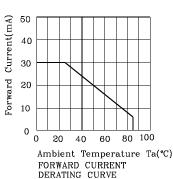


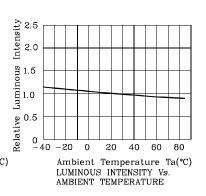


#### **♦** Blue

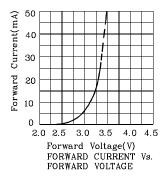


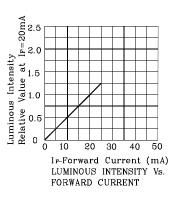


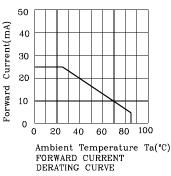


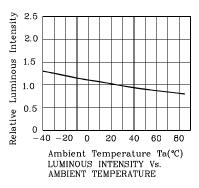


#### Green

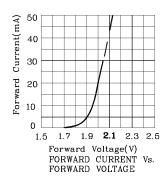


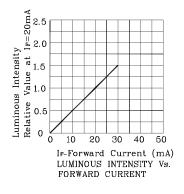


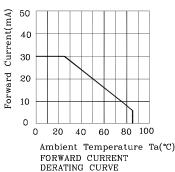


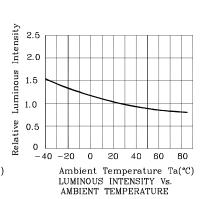


#### Red









Aug 24, 2017

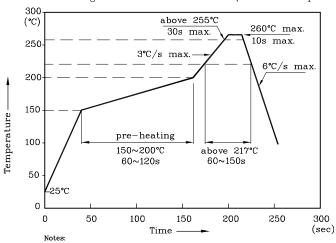
XDSB6706 V3-Z Layout: Maggie L.





#### LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

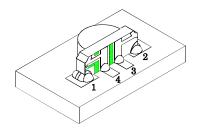


- 1. All temperatures refer to the center of the package,
- measured on the package body surface facing up during reflow.

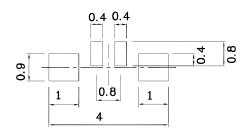
  2. Do not apply any stress to the LED during high temperature conditions.

  3. Maximum number of soldering passes: 2

❖ The device has a single mounting surface. The device must be mounted according to the specifications.



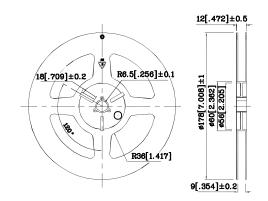
**❖** Recommended Soldering Pattern (Units: mm; Tolerance:  $\pm 0.1$ )



## **❖** Tape Specification (Units:mm)

# TAPE $4.0 \pm 0.1$ 75±0.1 $2.0\pm0.1$ $4.0 \pm 0.1$ $\emptyset 1.5 \pm 0.1$ $8.0\pm 0.03$ 5±0.0

### Reel Dimension



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

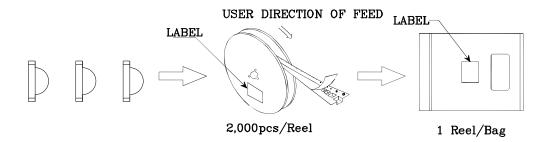
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

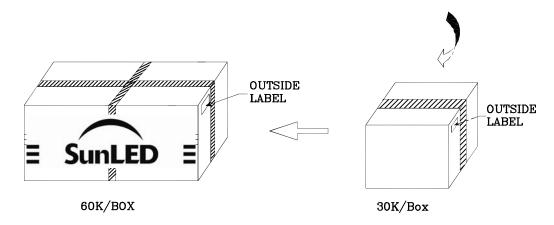
Note: Accuracy may depend on the sorting parameters.

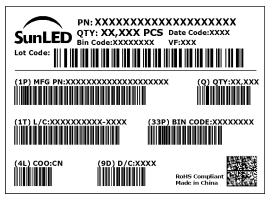




#### PACKING & LABEL SPECIFICATIONS







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- 6. Additional technical notes are available at <a href="http://www.SunLEDusa.com/TechnicalNotes.asp">http://www.SunLEDusa.com/TechnicalNotes.asp</a>

Aug 24, 2017 XDSB6706 V3-Z Layout: Maggie L.